

MM74HCT14 Hex Inverting Schmitt Trigger

General Description

The MM74HCT14 utilizes advanced silicon-gate CMOS technology to achieve the low power dissipation and high noise immunity of standard CMOS, as well as the capability to drive 10 LS-TTL loads.

The 74HCT logic family is functionally and pinout compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

Features

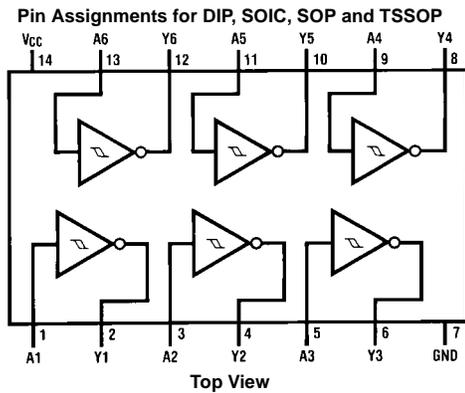
- Typical propagation delay: 13 ns
- Wide power supply range: 2–6V
- Low quiescent current: 10 μ A maximum
- Low input current: 1 μ A maximum
- Fanout of 10 LS-TTL loads
- Typical hysteresis voltage: 0.9V at $V_{CC} = 4.5V$
- TTL, LS pin-out and input threshold compatible

Ordering Codes:

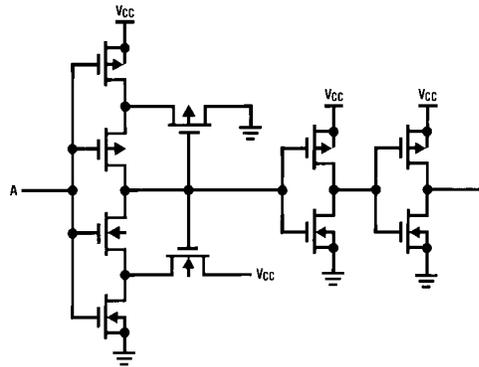
Order Number	Package Number	Package Description
MM74HCT14M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
MM74HCT14MX_NL	M14A	Pb-Free 14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
MM74HCT14SJ	M14D	Pb-Free 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
MM74HCT14MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HCT14N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.
Pb-Free package per JEDEC J-STD-020B.

Connection Diagram



Schematic Diagram



Absolute Maximum Ratings (Note 1)

(Note 2)

Supply Voltage (V_{CC})	-0.5 to +7.0V
DC Input Voltage (V_{IN})	-1.5 to $V_{CC} + 1.5V$
DC Output Voltage (V_{OUT})	-0.5 to $V_{CC} + 0.5V$
Clamp Diode Current (I_{IK}, I_{OK})	± 20 mA
DC Output Current, per pin (I_{OUT})	± 25 mA
DC V_{CC} or GND Current, per pin (I_{CC})	± 50 mA
Storage Temperature Range (T_{STG})	-65°C to +150°C
Lead Temperature (T_L) (Soldering 10 seconds)	260°C

Recommended Operating Conditions

	Min	Max	Units
Supply Voltage (V_{CC})	2	6	V
DC Input or Output Voltage (V_{IN}, V_{OUT})	0	V_{CC}	V
Operating Temperature Range (T_A)	-40	+85	°C

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur.

Note 2: Unless otherwise specified all voltages are referenced to ground.

DC Electrical Characteristics (Note 3)

Symbol	Parameter	Conditions	V_{CC}	$T_A = 25^\circ\text{C}$		$T_A = -40 \text{ to } 85^\circ\text{C}$		Units
				Typ	Guaranteed Limits			
V_{T+}	Positive Going Threshold Voltage	Minimum	4.5V	1.5	1.2	1.2	V	
			5.5V	1.7	1.4	1.4	V	
		Maximum	4.5V	1.5	1.9	1.9	V	
			5.5V	1.7	2.1	2.1	V	
V_{T-}	Negative Going Threshold Voltage	Minimum	4.5V	0.9	0.5	0.5	V	
			5.5V	1.0	0.6	0.6	V	
		Maximum	4.5V	0.9	1.2	1.2	V	
			5.5V	1.0	1.4	1.4	V	
V_H	Hysteresis Voltage	Minimum	4.5V	0.6	0.4	0.4	V	
			5.5V	0.7	0.4	0.4	V	
		Maximum	4.5V	0.6	1.4	1.4	V	
			5.5V	0.7	1.5	1.5	V	
V_{OH}	Minimum HIGH Level Output Voltage	$V_{IN} = V_{IL}$ $ I_{OUT} = 20 \mu\text{A}$ $ I_{OUT} = 4.0 \text{ mA}, V_{CC} = 4.5V$ $ I_{OUT} = 4.8 \text{ mA}, V_{CC} = 5.5V$		V_{CC}	$V_{CC} - 0.1$	$V_{CC} - 0.1$	V	
				4.2	3.98	3.84	V	
				5.2	4.98	4.98	V	
V_{OL}	Maximum LOW Level Voltage	$V_{IN} = V_{IH}$ $ I_{OUT} = 20 \mu\text{A}$ $ I_{OUT} = 4.0 \text{ mA}, V_{CC} = 4.5V$ $ I_{OUT} = 4.8 \text{ mA}, V_{CC} = 5.5V$		0	0.1	0.1	V	
				0.2	0.26	0.33	V	
				0.2	0.26	0.33	V	
I_{IN}	Maximum Input Current	$V_{IN} = V_{CC}$ or GND V_{IH} or V_{IL}			± 0.1	± 1.0	μA	
I_{CC}	Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND $I_{OUT} = 0 \mu\text{A}$ $V_{IN} = 2.4V$ or $0.5V$ (Note 3)	5.5V		1.0	10	μA	
			5.5V		2.4	2.4	mA	

Note 3: For a power supply of $5V \pm 10\%$ the worst case output voltages (V_{OH} , and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at $V_{CC} = 5.5V$ and $4.5V$ respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN} , I_{CC} , and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

AC Electrical Characteristics

$V_{CC} = 5V, T_A = 25^\circ C, C_L = 15 pF, t_r = t_f = 6 ns$

Symbol	Parameter	Conditions	Typ	Guaranteed Limit	Units
t_{PHL}, t_{PLH}	Maximum Propagation Delay		10	18	ns

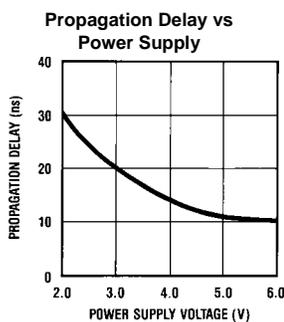
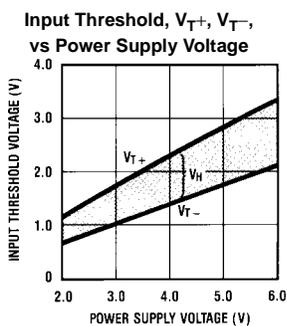
AC Electrical Characteristics

$V_{CC} = 5V \pm 10\%, C_L = 50 pF, t_r = t_f = 6 ns$ (unless otherwise specified)

Symbol	Parameter	Conditions	$T_A = 25^\circ$		$T_A = -40 \text{ to } 85^\circ C$		Units
			Typ	Guaranteed Limits	Typ	Guaranteed Limits	
t_{PHL}, t_{PLH}	Maximum Propagation Delay			20	25		ns
t_{TLH}, t_{THL}	Maximum Output Rise and Fall Time		9	15	19		ns
C_{PD}	Power Dissipation Capacitance (Note 4)	(per gate)		25			pF
C_{IN}	Maximum Input Capacitance		5	10	10		pF

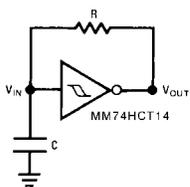
Note 4: C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.

Typical Performance Characteristics



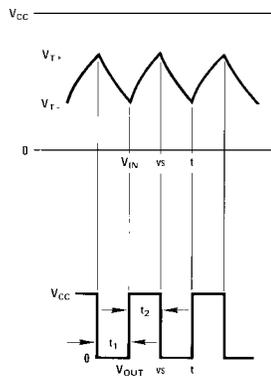
Typical Applications

Low Power Oscillator



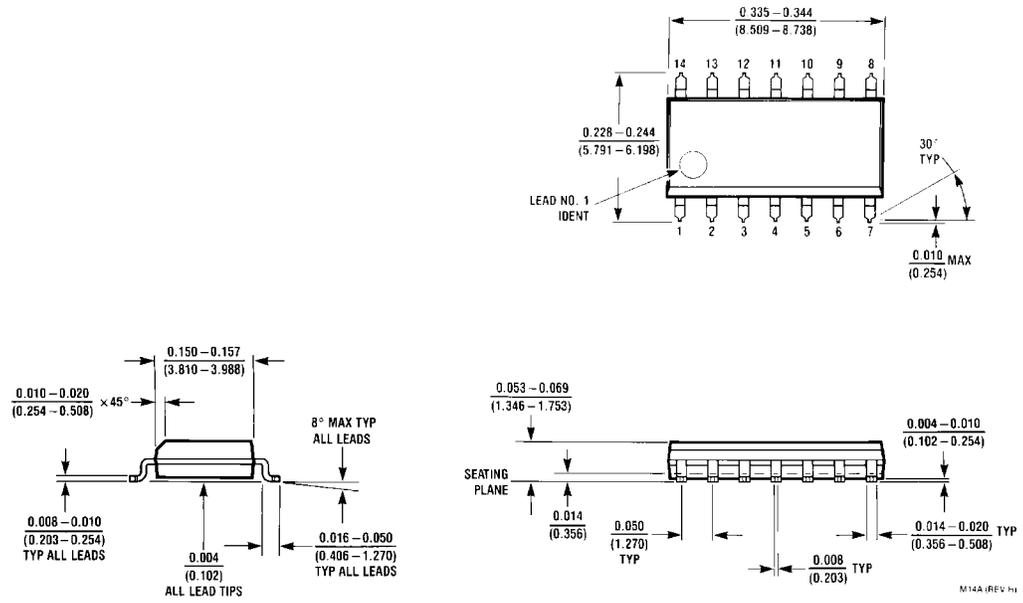
$$t_2 \approx RC \ln \frac{V_{CC} - V_{T-}}{V_{CC} - V_{T+}}$$

$$f \approx \frac{1}{RC \ln \frac{V_{T+} (V_{CC} - V_{T-})}{V_{T-} (V_{CC} - V_{T+})}}$$



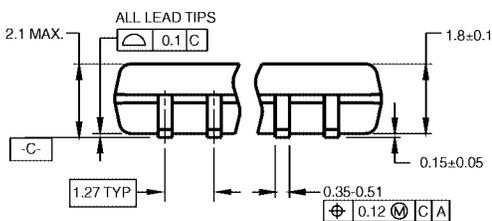
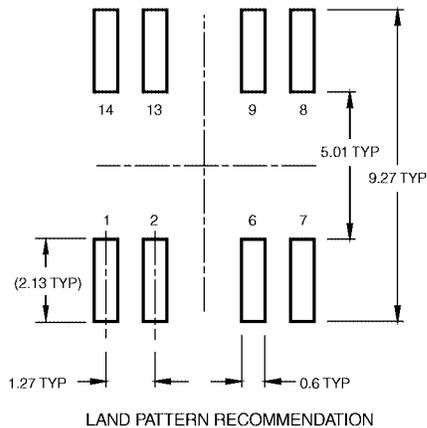
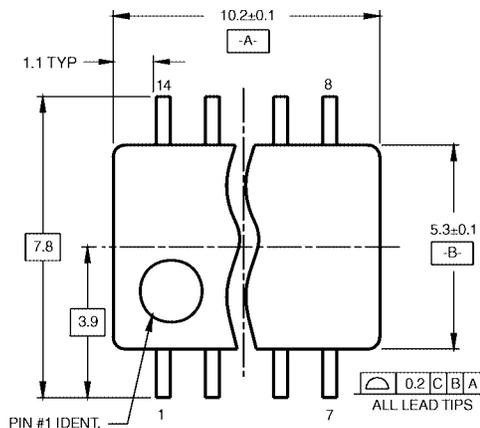
Note: The equations assume $t_1 + t_2 \gg t_{pd0} + t_{pd1}$

Physical Dimensions inches (millimeters) unless otherwise noted

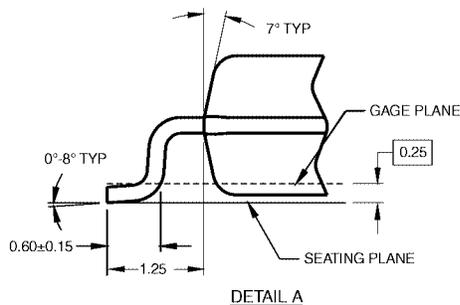
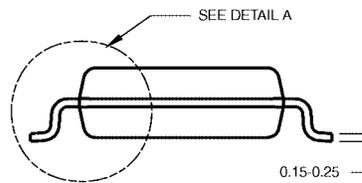


**14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
Package Number M14A**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



DIMENSIONS ARE IN MILLIMETERS

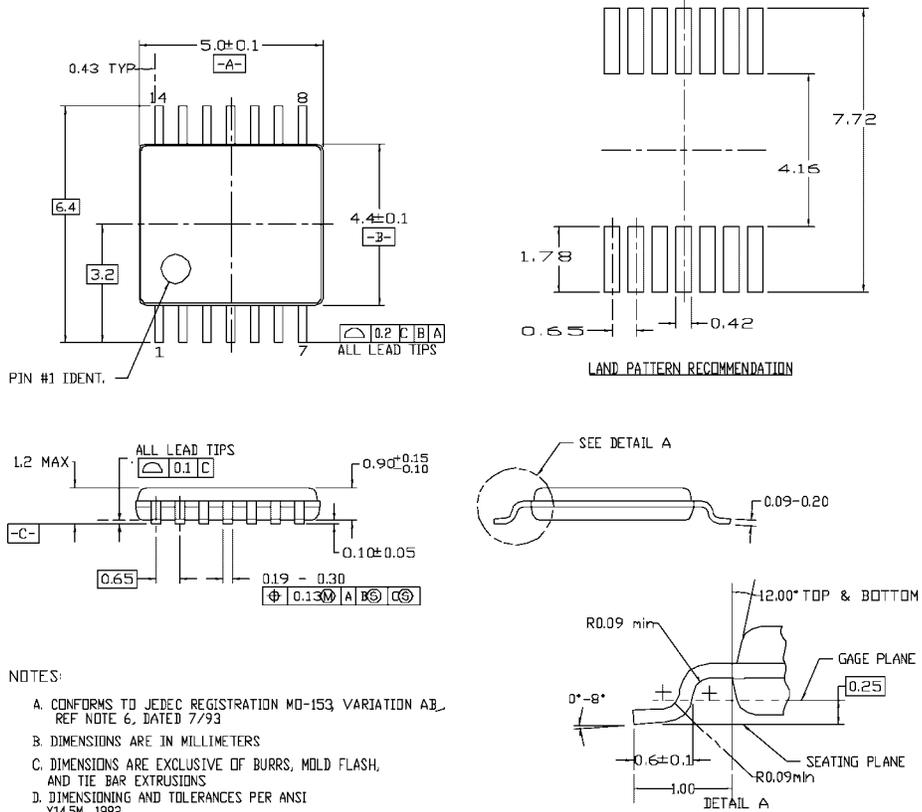


- NOTES:
- A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
 - B. DIMENSIONS ARE IN MILLIMETERS.
 - C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M14DRevB1

Pb-Free 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide Package Number M14D

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

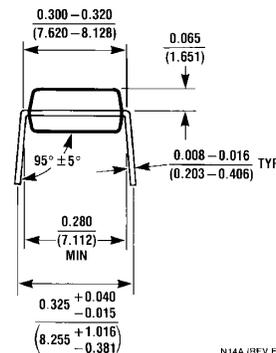
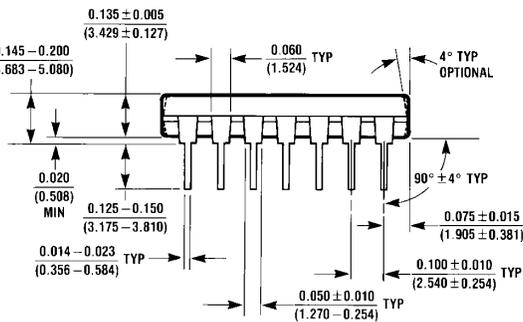
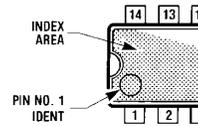
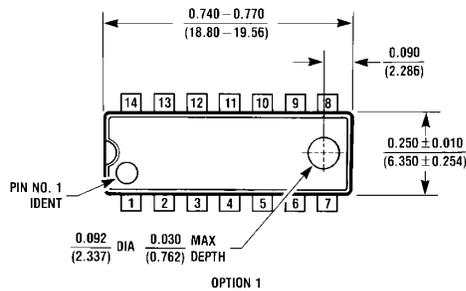


- NOTES:
- A. CONFORMS TO JEDEC REGISTRATION MO-153 VARIATION AB, REF NOTE 6, DATED 7/93
 - B. DIMENSIONS ARE IN MILLIMETERS
 - C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
 - D. DIMENSIONING AND TOLERANCES PER ANSI Y14.5M, 1982

MTC14revD

14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC14

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N14A

N14A (REV F)

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